1-1747145-7 ACTIVE

Dynamic Series | Dynamic DZ 5200 Series

TE Internal #: 1-1747145-7

PCB Mount Header, Right Angle, Board-to-Board, 7 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold (Au), Dynamic DZ 5200

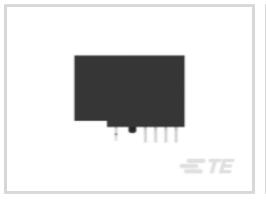
Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Right Angle Connector System: Board-to-Board

Number of Positions: 7
Number of Rows: 1

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Board-to-Board Configuration	Perpendicular
PCB Mount Orientation	Right Angle
Number of Positions	7
Number of Rows	1

Body Features

Primary Product Color Black

Contact Features



Contact Mating Area Plating Material Thickness	.2 μm[8 μin]
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Current Rating (Max)	20 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
PCB Mount Retention Type	Retention Leg
PCB Mount Retention	With
PCB Mount Alignment	Without
Mating Alignment	With
Housing Features	
Housing Material	PBT GF
Centerline (Pitch)	5.08 mm[.2 in]
Dimensions	
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



(24 Ca (24	Current ECHA Candidate List: JAN 2025 247) Candidate List Declared Against: JAN 2025 247) Does not contain REACH SVHC
	Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Wave solder capable to 265°C

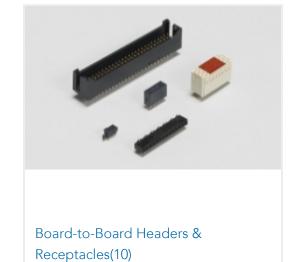
Product Compliance Disclaimer

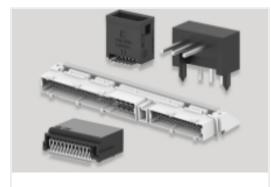
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Dynamic DZ 5200 Series







PCB Headers & Receptacles(10)

Rectangular Power Connectors(10)

Customers Also Bought

















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-1747145-7_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-1747145-7_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1747145-7_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

Japanese